

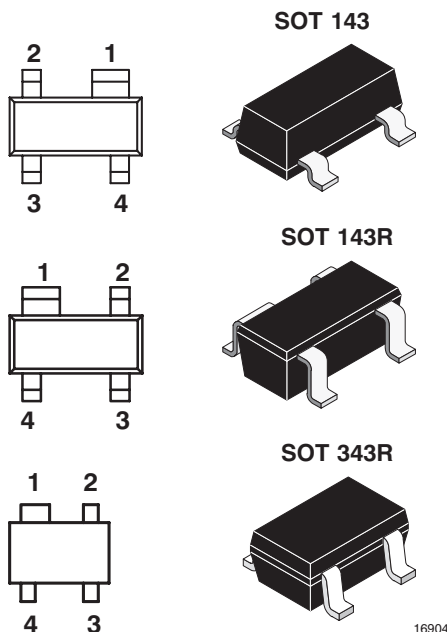
MOSMIC[®] for TV-Tuner Prestage with 5 V Supply Voltage

Comments

MOSMIC - MOS Monolithic Integrated Circuit

Features

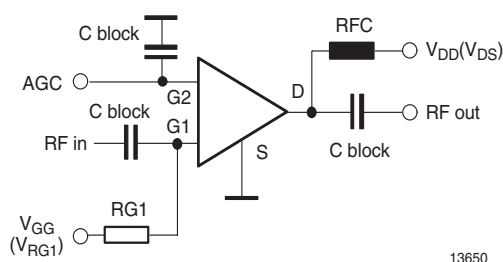
- Easy Gate 1 switch-off with PNP switching transistors inside PLL
- Integrated gate protection diodes
- Low noise figure, high gain
- Typical forward transadmittance of 28 mS
- Partly internal self biasing-network on chip
- Superior cross modulation at gain reduction
- High AGC-range with soft slope
- Main AGC control range from 3 V to 0.5 V
- Supply voltage 5 V (3 V to 7 V)
- SMD package, standard and reverse pinning



Electrostatic sensitive device.
Observe precautions for handling.

Applications

Low noise gain controlled VHF and UHF input stages, such as in digital and analog TV tuners.



Mechanical Data

Typ: S506TY

Case: Plastic case (SOT 143)

Weight: 8 mg

Pinning: 1 = Source, 2 = Drain,
3 = Gate 2, 4 = Gate 1

Typ: S506TYR

Case: Plastic case (SOT 143R)

Weight: 8 mg

Pinning: 1 = Source, 2 = Drain,
3 = Gate 2, 4 = Gate 1

Typ: S506TYRW

Case: Plastic case (SOT 343R)

Weight: 6 mg

Pinning: 1 = Source, 2 = Drain,
3 = Gate 2, 4 = Gate 1

Parts Table

Part	Marking	Package
S506TY	Y06	SOT143
S506TYR	Y6R	SOT143R
S506TYRW	WY6	SOT343R

Absolute Maximum Ratings

T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Drain - source voltage		V _{DS}	8	V
Drain current		I _D	30	mA
Gate 1/Gate 2 - source peak current		± I _{G1/G2SM}	10	mA
Gate 1 - source voltage		+ V _{G1SM}	6	V
		- V _{G1SM}	1.5	V
Gate 2 - source voltage		± V _{G2SM}	6	V
Total power dissipation	T _{amb} ≤ 60 °C	P _{tot}	200	mW
Channel temperature		T _{Ch}	150	°C
Storage temperature range		T _{stg}	- 55 to + 150	°C

Maximum Thermal Resistance

Parameter	Test condition	Symbol	Value	Unit
Channel ambient	1)	R _{thChA}	450	K/W

on glass fibre printed board (25 x 20 x 1.5) mm³ plated with 35 µm Cu

Electrical DC Characteristics

T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Drain - source breakdown voltage	I _D = 10 µA, V _{G1S} = V _{G2S} = 0	V _{(BR)DSS}	12			V
Gate 1 - source breakdown voltage	+ I _{G1S} = 10 mA, V _{G2S} = V _{DS} = 0	+ V _{(BR)G1SS}	7		10	V
Gate 2 - source breakdown voltage	± I _{G2S} = 10 mA, V _{G1S} = V _{DS} = 0	± V _{(BR)G2SS}	7		10	V
Gate 1 - source leakage current	+ V _{G1S} = 5 V, V _{G2S} = V _{DS} = 0	+ I _{G1SS}			20	nA
Gate 2 - source leakage current	± V _{G2S} = 5 V, V _{G1S} = V _{DS} = 0	± I _{G2SS}			20	nA
Drain - source operating current	V _{DS} = V _{RG1} = 5 V, V _{G2S} = 4 V, R _{G1} = 56 kΩ	I _{DSO}	8	12	17	mA
Gate 1 - source cut-off voltage	V _{DS} = 5 V, V _{G2S} = 4, I _D = 20 µA	V _{G1S(OFF)}	0.3		1.0	V
Gate 2 - source cut-off voltage	V _{DS} = V _{RG1} = 5 V, R _{G1} = 56 kΩ, I _D = 20 µA	V _{G2S(OFF)}	0.3	1.0	1.2	V

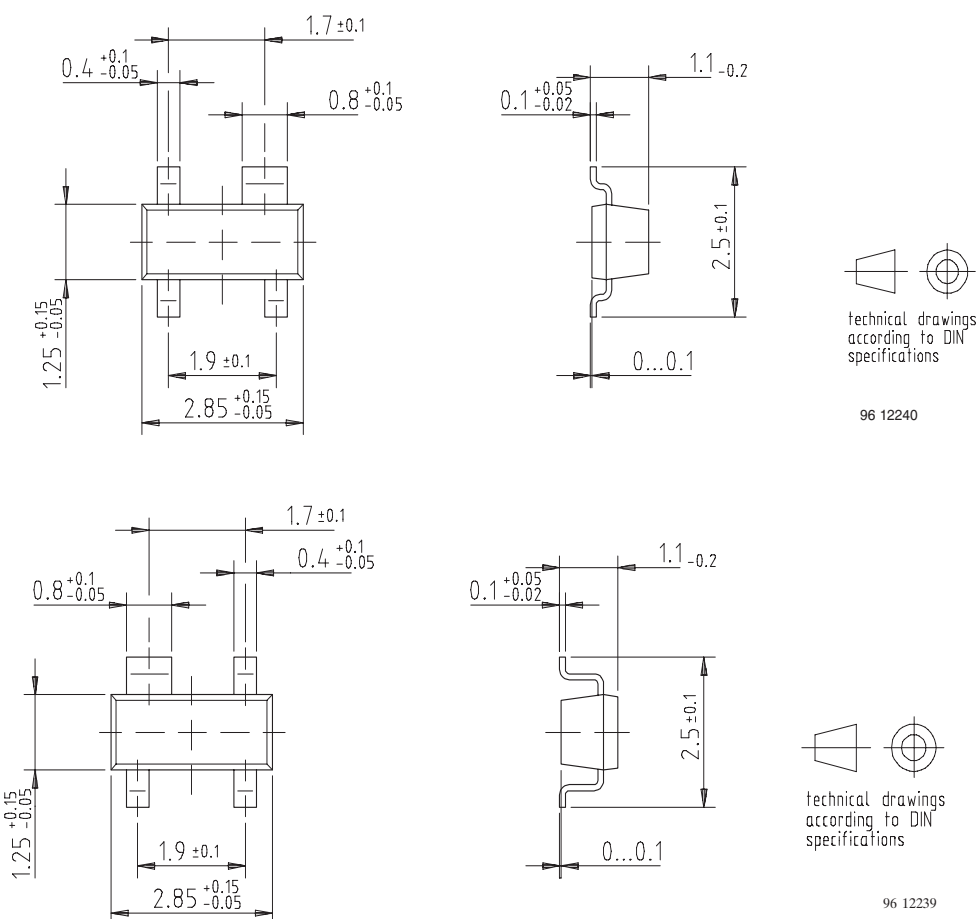
Electrical AC Characteristics

T_{amb} = 25 °C, unless otherwise specifiedV_{DS} = V_{RG1} = 5 V, V_{G2S} = 4 V, R_{G1} = 56 kΩ, I_D = I_{DSO}, f = 1 MHz

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Forward transadmittance		y _{21s}	23	28	33	mS
Gate 1 input capacitance		C _{issg1}		2.5	3.0	pF
Feedback capacitance		C _{rss}		20		fF
Output capacitance		C _{oss}		0.9		pF

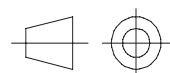
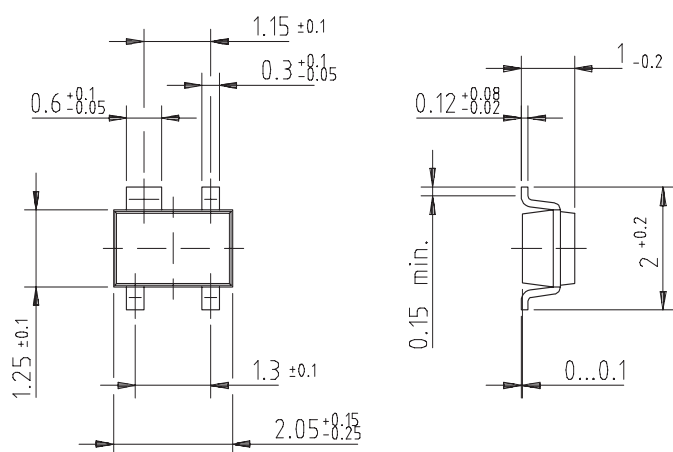
Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Power gain	$G_S = 2 \text{ mS}$, $B_S = B_{Sopt}$, $G_L = 0.5 \text{ mS}$, $B_L = B_{Lopt}$, $f = 200 \text{ MHz}$	G_{ps}		32		dB
	$G_S = 2 \text{ mS}$, $B_S = B_{Sopt}$, $G_L = 1 \text{ mS}$, $B_L = B_{Lopt}$, $f = 400 \text{ MHz}$	G_{ps}		28		dB
	$G_S = 3.3 \text{ mS}$, $B_S = B_{Sopt}$, $G_L = 1 \text{ mS}$, $B_L = B_{Lopt}$, $f = 800 \text{ MHz}$	G_{ps}		22		dB
AGC range	$V_{DS} = 5 \text{ V}$, $V_{G2S} = 0.5 \text{ to } 4 \text{ V}$, $f = 200 \text{ MHz}$	G_{ps}		50		dB
Noise figure	$G_S = G_L = 20 \text{ mS}$, $B_S = B_L = 0$, $f = 50 \text{ MHz}$	F		4.5	6.0	dB
	$G_S = 2 \text{ mS}$, $G_L = 1 \text{ mS}$, $B_S = B_{Sopt}$, $f = 400 \text{ MHz}$	F		1.0	1.6	dB
	$G_S = 3.3 \text{ mS}$, $G_L = 1 \text{ mS}$, $B_S = B_{Sopt}$, $f = 800 \text{ MHz}$	F		1.5	2.3	dB
Cross modulation	Input level for $k = 1 \% @ 0 \text{ dB AGC}$ $f_w = 50 \text{ MHz}$, $f_{unw} = 60 \text{ MHz}$	X_{mod}	90			dB μ V
	Input level for $k = 1 \% @ 40 \text{ dB AGC}$ $f_w = 50 \text{ MHz}$, $f_{unw} = 60 \text{ MHz}$	X_{mod}	105			dB μ V

Package Dimensions in mm



S506TY/S506TYR/S506TYRW

Vishay Semiconductors



technical drawings
according to DIN
specifications

96 12238



Ozone Depleting Substances Policy Statement

It is the policy of **Vishay Semiconductor GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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